FR3A THRU FR3M

GROWCHILD ELECTRONICSTM

SURFACE MOUNT FAST RECOVERY RECTIFIER

REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 3.0 AMPERE

http://www.njzrg.com

FEATURES

- · For surface mounted applications
- · Low profile package
- · Built-in strain relief
- · Easy pick and place
- · Fast Recovery times for high efficiency
- · Plastic package has Underwriters Laboratory

Flammability Classification 94V-O

· High temperature soldering : 260°C /10 seconds at terminals

MECHANICAL DATA

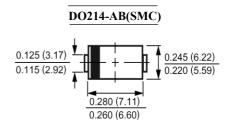
Case: Molded plastic, DO-214AB(SMC)

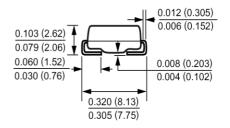
Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 16mm tape per EIA STD RS-481

Weight: 0.007 ounce, 0.21 gram





Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, $60H_Z$, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	FR3A	FR3B	FR3D	FR3G	FR3J	FR3K	FR3M	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T_L =75	I _(AV)	3.0							Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I_{FSM}	I _{FSM} 100							
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 3.0A	$V_{\rm F}$	1.3							Volts
Maximum Reverse Current at T _A =25	1	5.0							u A mm
at Rated DC Blocking Voltage T _A =125	I_R			300					μАтр
Typical Junction Capacitance (Note 1)	C _J	60							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	50 15							/W
	$R_{\theta JL}$								
Maximum Reverse Recovery Time (Note 3)	T_{RR}		1	50		250	5	00	nS
Operating Junction Temperature Range	T_{J}	-55 to +150							
Storage Temperature Range	Tstg	-55 to +150							

NOTES:

- 1- Measured at 1 MH_Z and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas
- 3- Reverse Recovery Test Conditions : $I_F \!\!=\! .5A$, $I_R \!\!=\! 1A$, $I_{RR} \!\!=\! .25A$.



RATINGS AND CHARACTERISTIC CURVES

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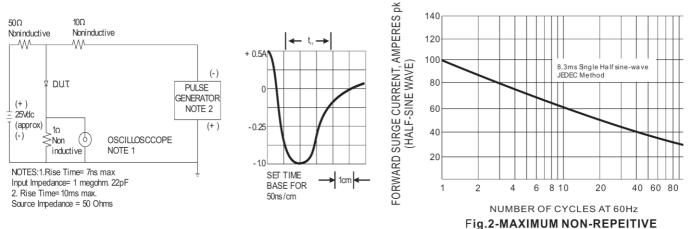


Fig.1-REVERSERECOVERY TIME CHARACTERISTIC AND TEST CIRCUITDIAGRAM



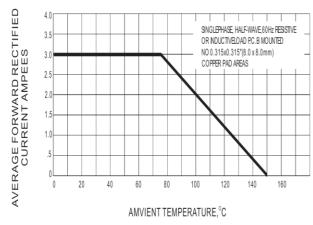


Fig. 3-MAXIMU AVERAGE FORWARD CURRENT RATING

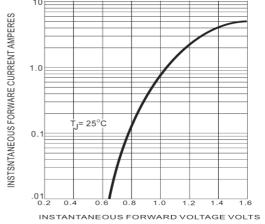


Fig. 4- FORWARD CURRRENT DERATING CUR\

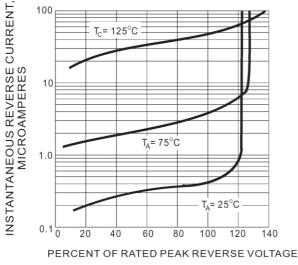


Fig. 5-TYPICAL REVERSE CHARACTERISTICS

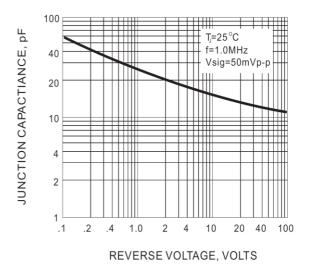


Fig.6-TYPICAL JUNCTION CAPACITANC